

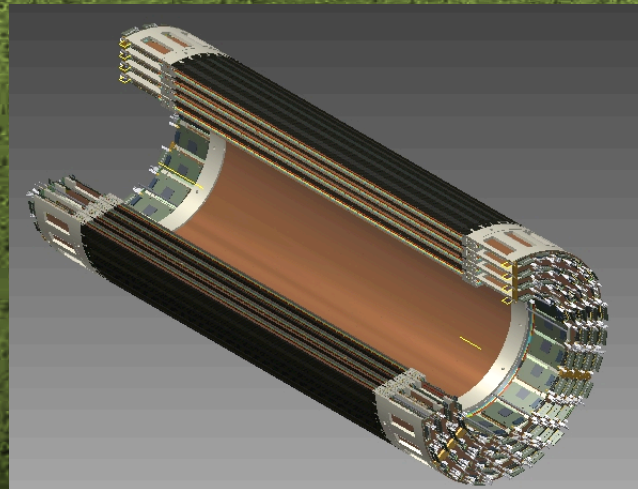
# Status of Cylindrical-GEM project for the KLOE-2 Inner Tracker

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## and possible Cylindrical-GEM in BESIII

BESIII Italian Collaboration

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# GEM detector features

- ❑ **flexible geometry** → arbitrary shape: rectangular, cylindrical ...
- ❑ **ultra-light structure** → very low material budget: <0.5% X<sub>0</sub>/chamber
- ❑ **gas multiplication separated from readout stage** → arbitrary readout pattern: pad, strips (XY, UV), mixed ...
- ❑ **high rate capability**: >50 MHz/cm<sup>2</sup>
- ❑ **high safe gains**: > 10<sup>4</sup>
- ❑ **high reliability**: low discharge,  $P_d < 10^{-12}$  per incoming particle
- ❑ **rad hard**: up to 2.2 C/cm<sup>2</sup> integrated over the whole active area without permanent damages (corresponding to 10 years of operation at LHCb1)
- ❑ **high spatial resolution**: down to 60μm (COMPASS with analog readout  
Nucl.Phys.Proc.Suppl. 125 (2003) 368-373)
- ❑ **good time resolution**: down to 3 ns (with CF<sub>4</sub>)



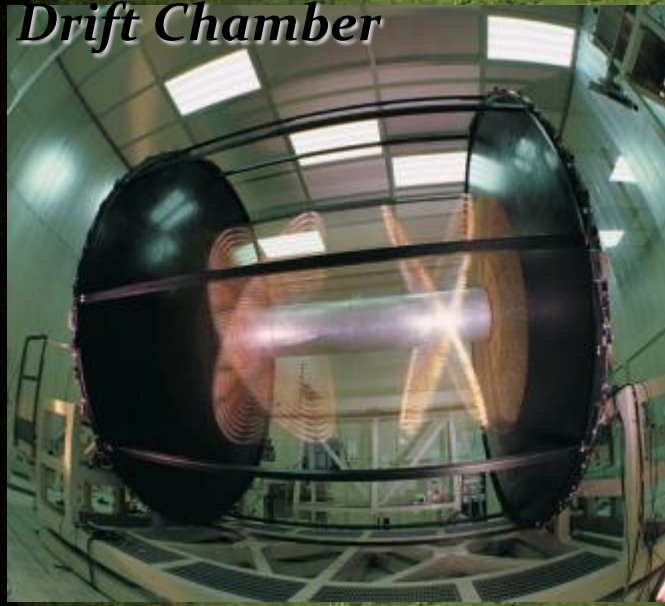
# KLOE at upgraded DAFNE f-factory (1020 MeV)

- 4 m diameter × 3.3 m length
- 90% helium, 10% isobutane
- 12582/52140 sense/tot wires
- All-stereo geometry

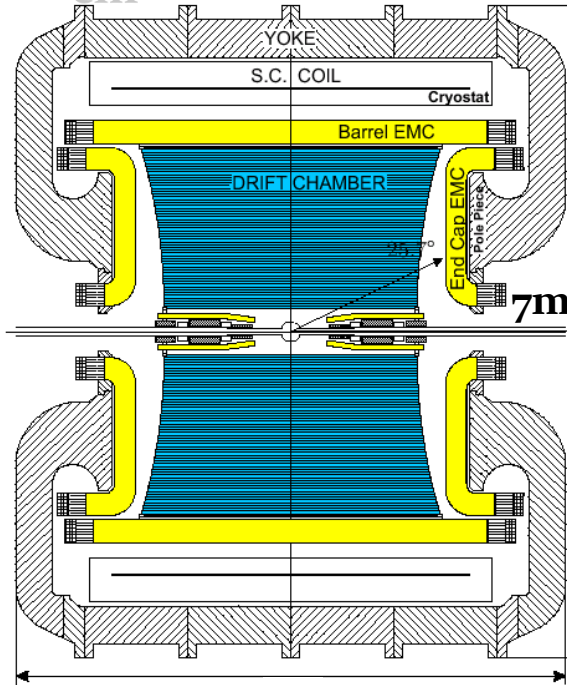
$$\begin{aligned} \chi_{KS} &= 0.6 \\ \chi_{KL} &= \\ 340 \text{ cm} \\ \chi_{K\Box} &= 95 \\ \text{cm} \end{aligned}$$

- Lead/scintillating fiber
- 98% coverage of solid angle
- 88 modules (barrel + end-caps)
- 4880 PMTs (two side read-out)

*Drift Chamber*



$$\begin{aligned} s_{rf} &= 150 \text{ mm} & s_z &= 2 \text{ mm} \\ s_y &= 3 \text{ mm} & s_p/p &= 0.4 \% \end{aligned}$$



$$B = 0.52 \text{ T}$$



*Electromagnetic*

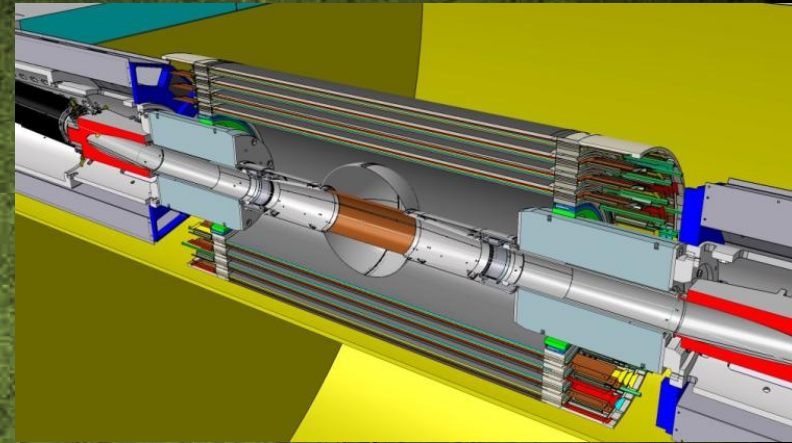
$$\begin{aligned} s_E/E &= 5.4\% \sqrt{E(\text{GeV})} \\ s_t &= 54 \text{ ps} \sqrt{E(\text{GeV})} \\ &\text{\AA } 100 \text{ ps(calib)} \end{aligned}$$



# KLOE-2 Inner Tracker

To improve vertex reconstruction of  $K_S$ ,  $\eta$  and  $\eta'$  and  $K_S$ - $K_L$  interference measurements:

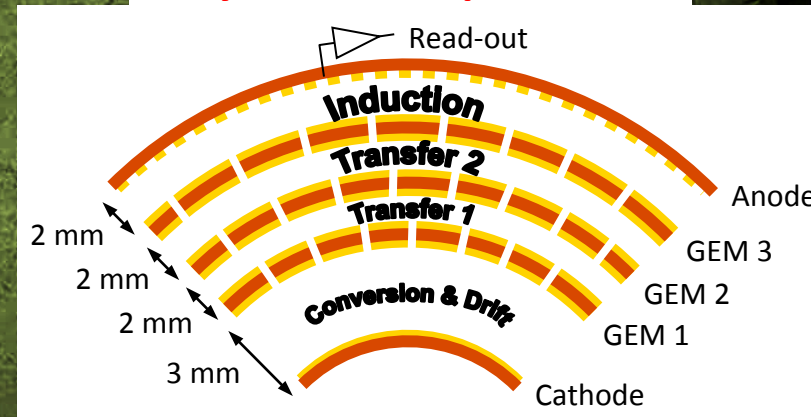
1.  $\sigma_{r\phi} \approx 200 \mu\text{m}$  and  $\sigma_z \approx 350 \mu\text{m}$
2. low material budget:  $< 2\% X_0$



## Cylindrical GEM detector is the adopted solution

- ❑ 4 CGEM layers :from IP to DC Inner wall
- ❑ 700 mm active length
- ❑ XV strips-pads readout ( $\sim 40^\circ$  stereo angle)
- ❑  $2\% X_0$  total radiation length in the active region

### Cylindrical Triple GEM

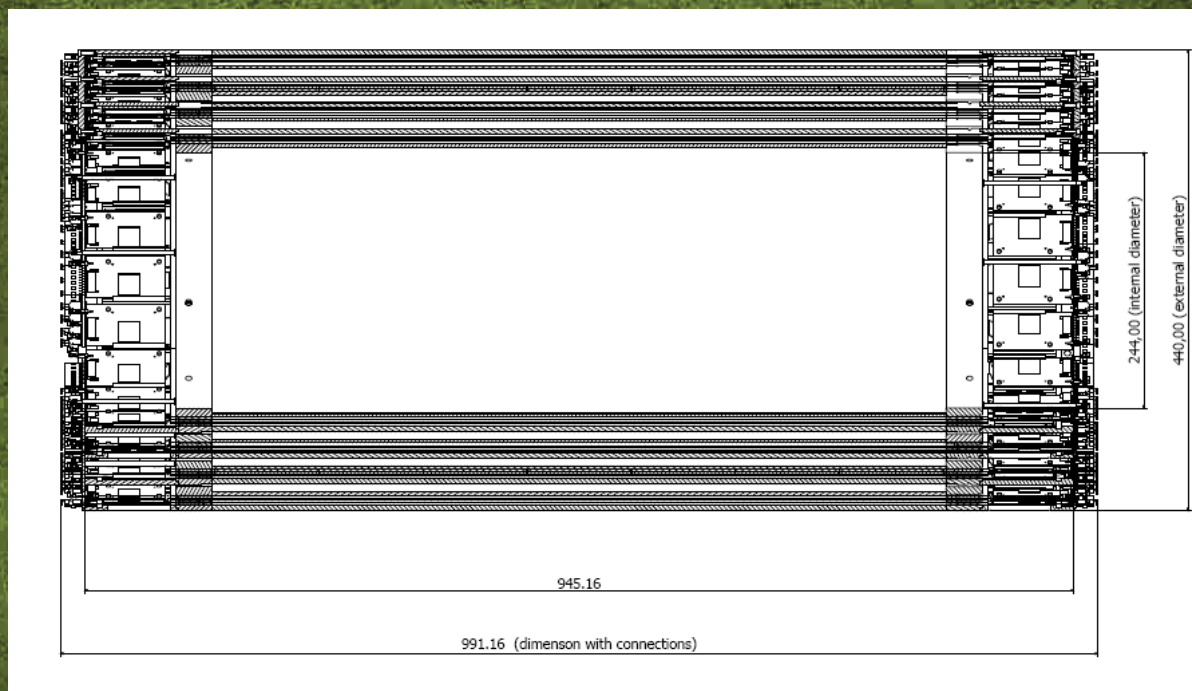


$K_S \rightarrow p^+ p^-$  vertex resolution will improve of about a factor 3 from present 6mm



# KLOE - IT dimensions

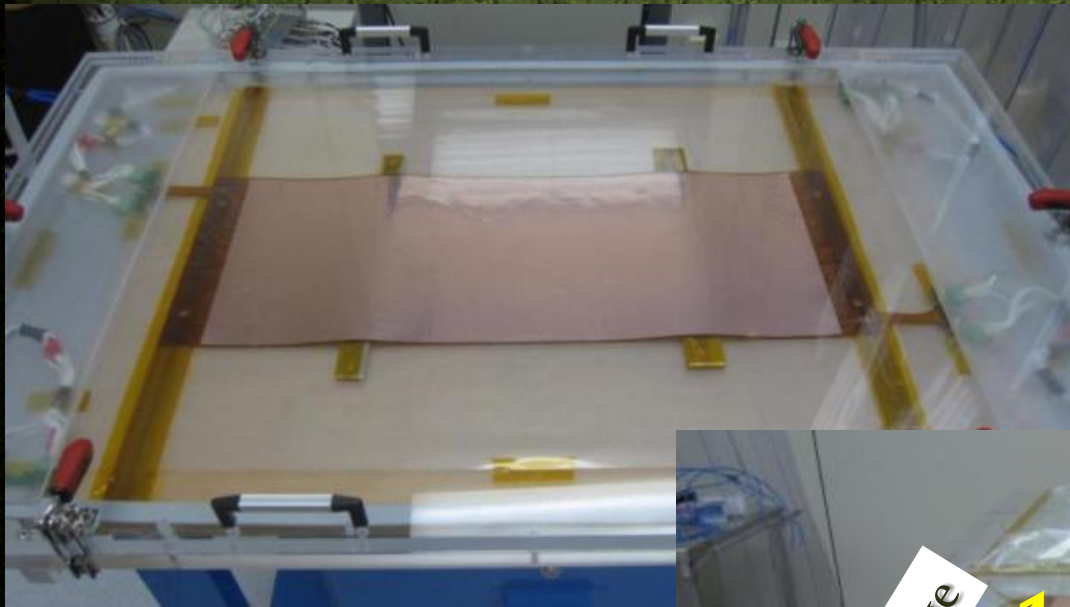
	Ext diam (mm)	Int diam (mm)
Layer 1	290	244
Layer2	340	294
Layer3	390	344
Layer4	440	394



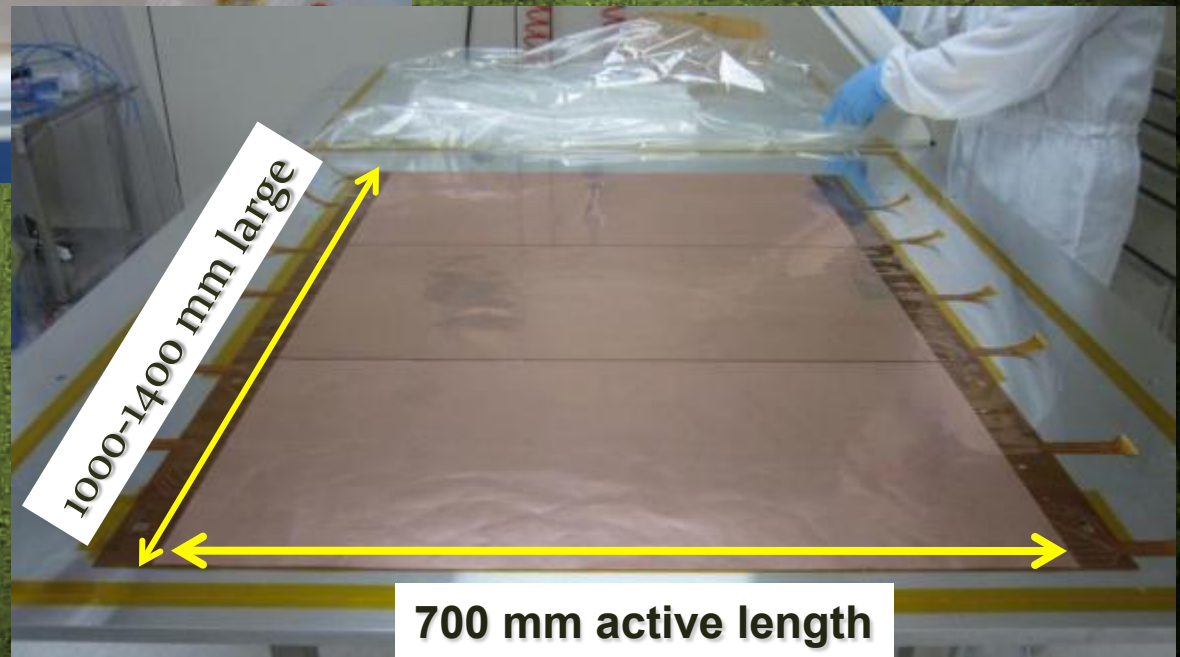
Total length 945,16 mm + connectors ~ 991,16 mm



# The Large GEM Foils



Before gluing each GEM foil, it is tested with HV (up to 600V) in a N<sub>2</sub> flushed plexiglass box, to reduce RH below 10%



3 GEM foils spliced and envelopped in a vacuum bag



# Anode Readout

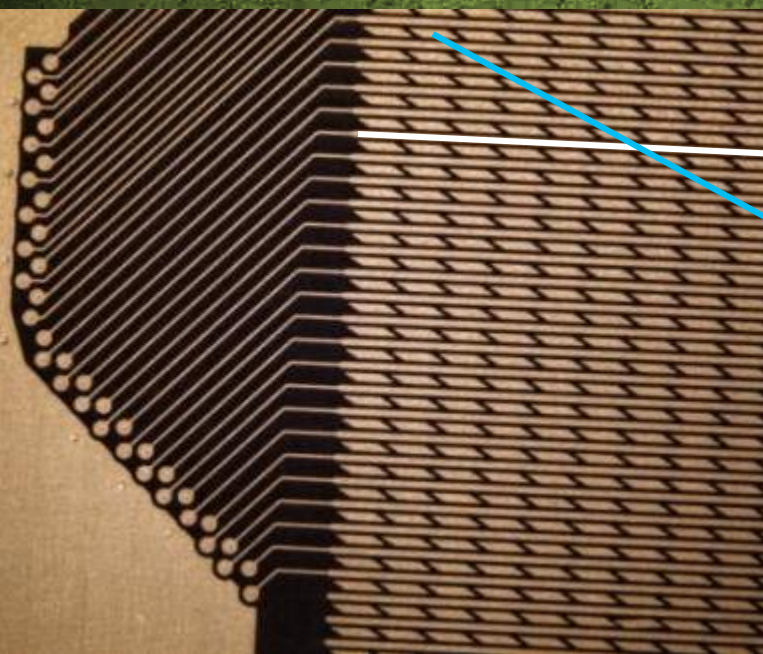


2-D readout with XV strips on the same plane

X pitch  $650\mu\text{m}$   $\square$  X res  $190\mu\text{m}$

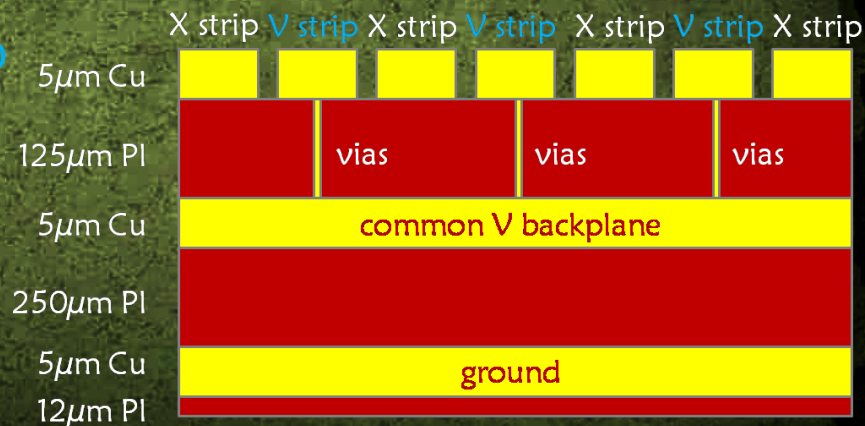
V pitch  $650\mu\text{m}$   $\square$  Y res  $350\mu\text{m}$

Multilayer Kapton circuit realized at CERN



X strip

V strip

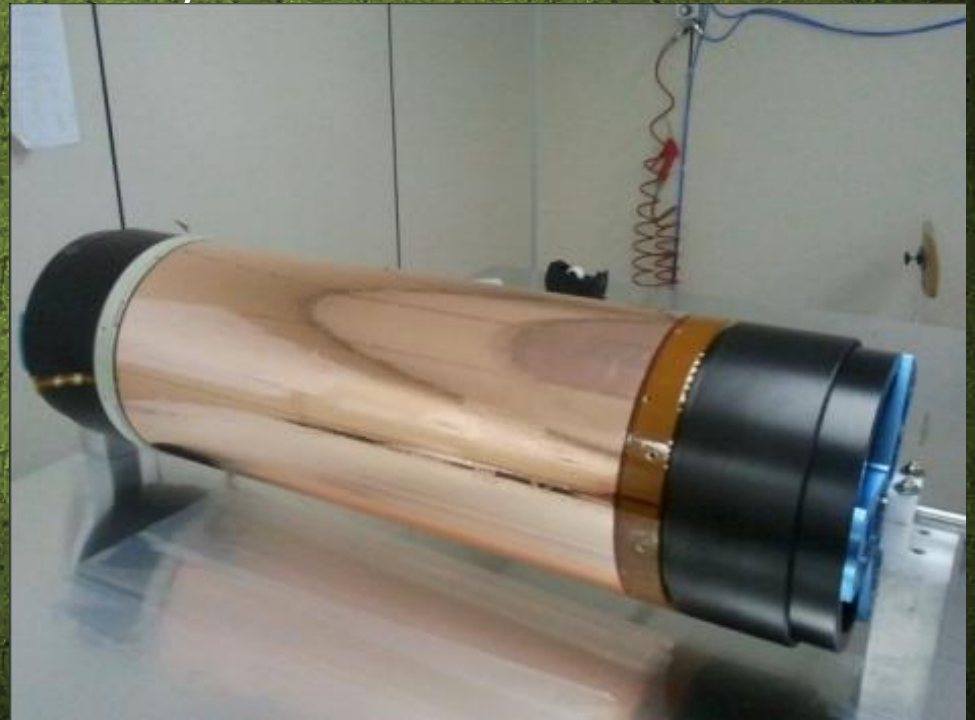




# Costruction toolings (I)



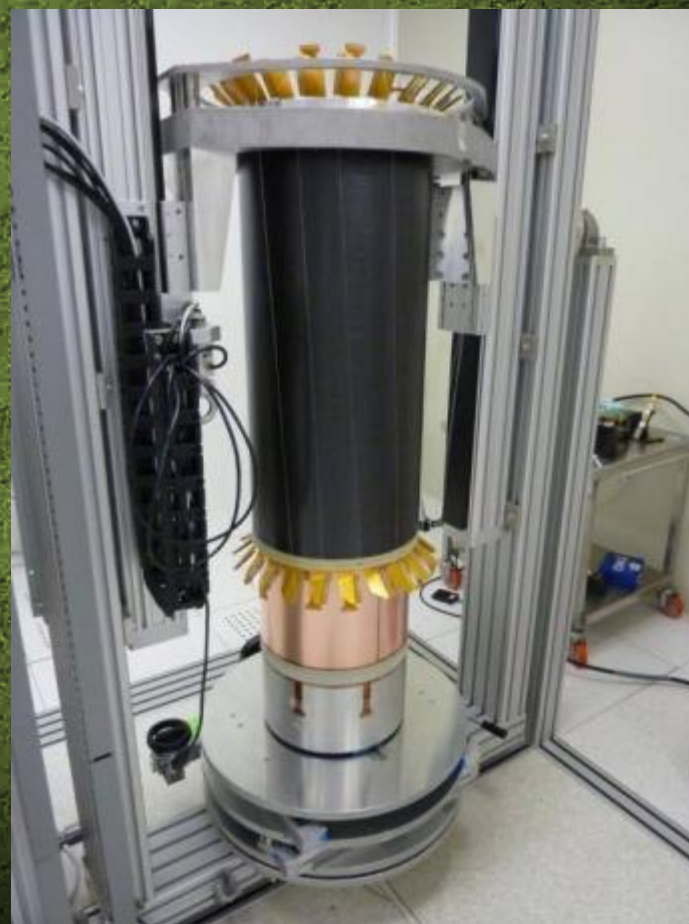
Special molds for cylindrical electrodes (cathode, GEMs, anode readout) constructions.  
N.5 molds per layer (total 20 molds)





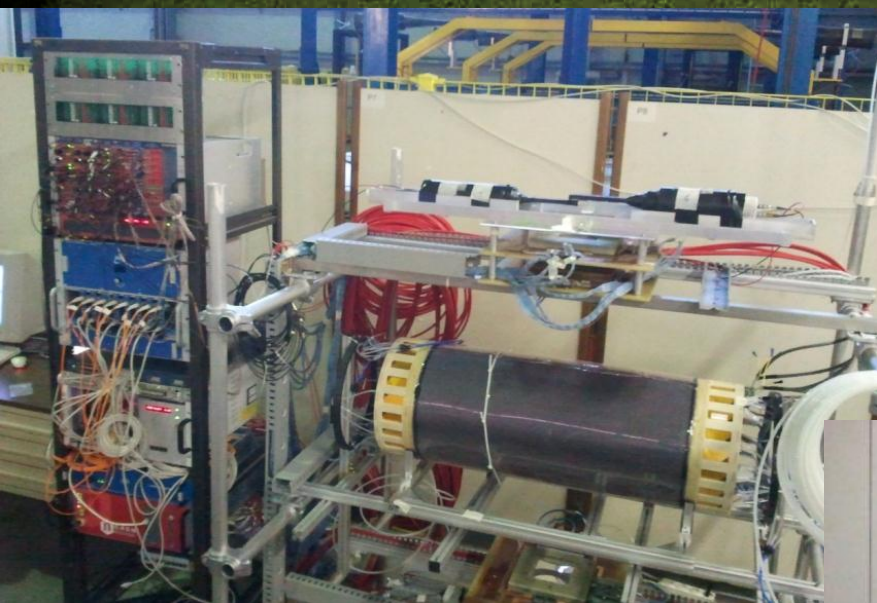
# Costruction toolings (II)

Vertical Insertion System for the cylindrical electrodes insertion and final detector assembly





# Layer 1 & Layer 2



Up to now, the first two layers have been made, and will be tested with cosmics.

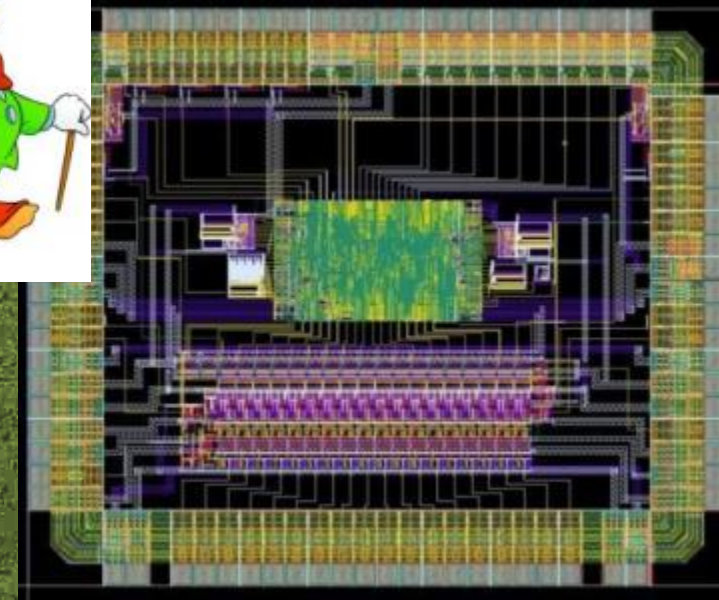


The manufacture of the other two layers should be completed in October 2012. The installation in KLOE is foreseen by the end of 2012



# GASTONE: the IT dedicated FEE chip

Sensitivity (pF)	20 mV/fC
$Z_{IN}$	400 $\Omega$ (low frequency)
$C_{DET}$	1 – 50 pF
Peaking time	90 – 200 ns (1-50 pF)
Noise (erms)	800 $e^-$ + 40 $e^-/pF$
Channels/chip	64*
Readout	LVDS/Serial
Power consum.	$\approx$ 0.6 mA/ch



- Mixed analog-digital circuit (KLOE-2 dedicated);
- Low input equivalent noise, low power consumption and high integrated chip;
- 4 blocks:
  - charge sensitive preamplifier
  - shaper
  - leading-edge discriminator (prog. thr.)
  - monostable (stretch digital signal to match the trigger timing of the experiment)

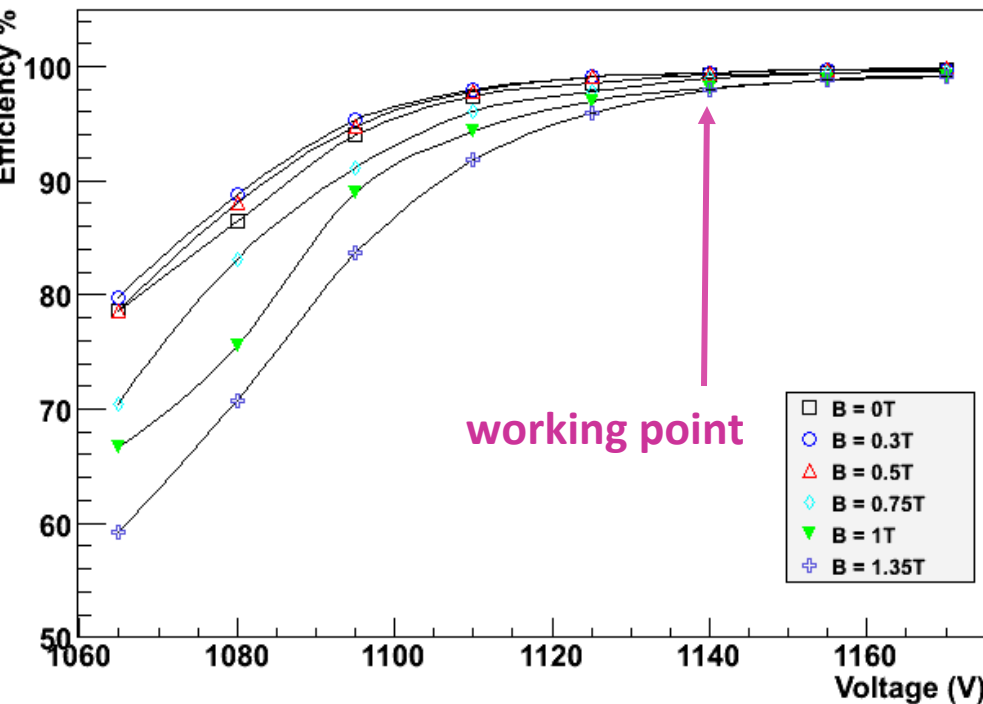
0.35 CMOS technology- no Rad-Hard





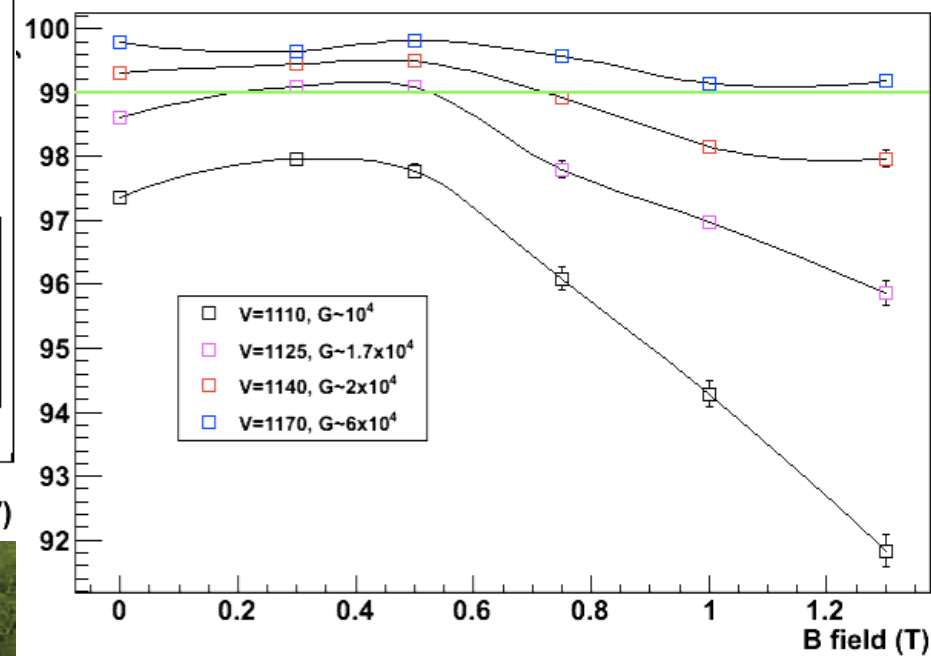
# Efficiency vs B field and Gain

Efficiency vs Voltage (th=3.5 fC)



At working point,  $V_G = 1140$  Volt,  
 $G \sim 2 \times 10^4$ , efficiency drop is negligible  
 for  $B < 0.5$  T

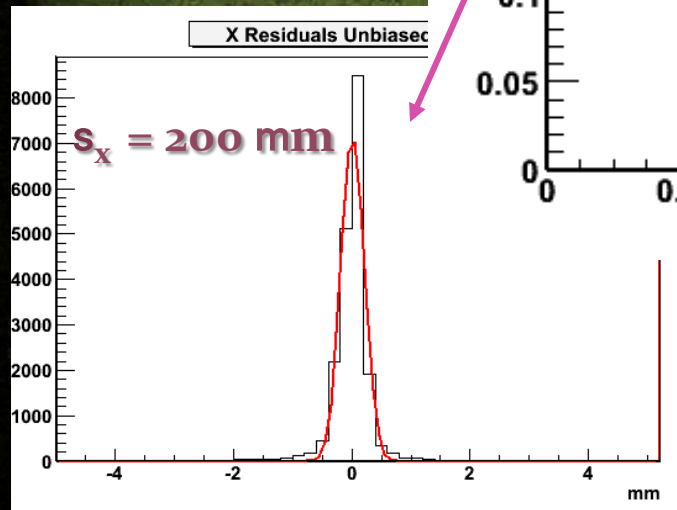
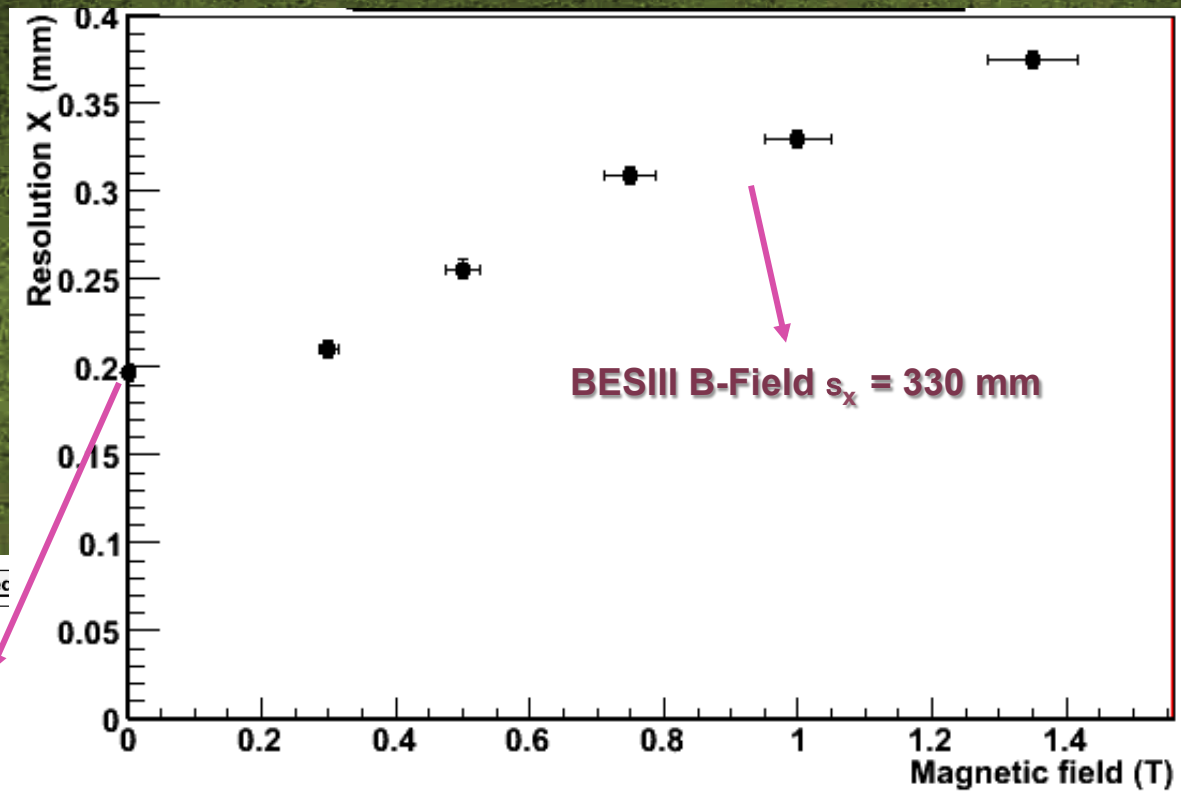
Efficiency vs B field



The increase of the magnetic field, increasing the spread of the charge over the readout strips (less charge is collected by each single pre-amp channel) results in an efficiency drop, thus requiring for higher gain to efficiently operate the detector.



# Spatial resolution: X-view ( $r-\phi$ )



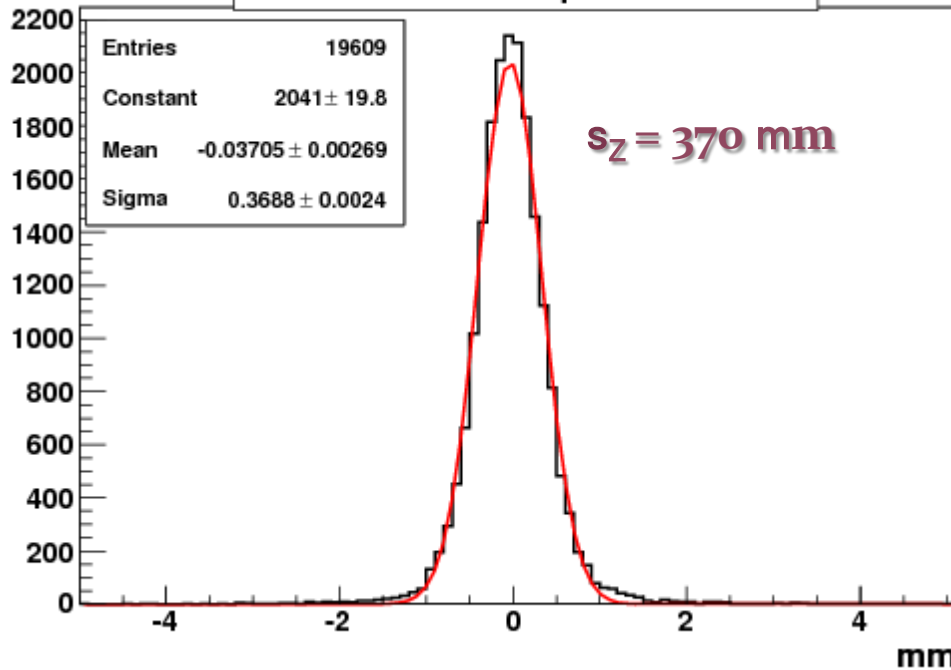
**Better resolution, if lower pitch or analog readout ( COMPASS  $s_x = 60$  mm )**



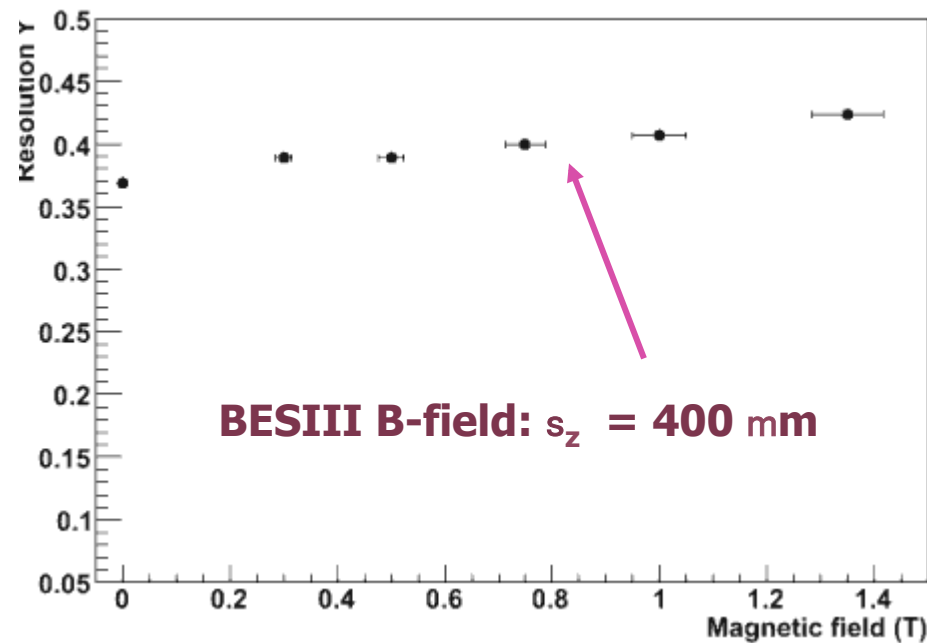
# Spatial resolution : Z-coordinate

The Z coordinate is determined from the crossing of X (r- $\phi$ ) and V views  
(Better z resolution , if lower pitch or analog readout)

Y residuals for X-V plane B = 0T



Resolution Y vs magnetic field



In BESIII:  $\sigma(s_x^2 + s_z^2) \sim 500$  mm  
(if analog readout  $\sim 150$  mm)



# A Cylindrical\_GEM at BESIII

## in case a new inner chamber is needed ?

- ❑ The manufacture of a Cylindrical\_GEM, which fulfills many BESIII needs, is on going at LNF and will be installed in KLOE-2 by the end of this year
- ❑ BESIII inner chamber is a bit smaller:
  - ❖ makes a Cylindrical\_GEM easier to be built,
  - ❖ enough space to allocate 4 triple-GEM,
  - ❖ equivalent to the present 8 layers,
  - ❖ **however, new tools (molds) are needed**



# BESIII GEM

## possible geometrical parameters

Layer	Int.diam (mm)	Ext.diam (mm)	Length (mm)	Foils
1	120	166	789+46	1
2	176	222	813+46	1
3	232	278	837+46	2
4	288	334	861+46	2



# BESIII GEM vs KLOE2 possible improvements

- ❑ Expertise from KLOE2 and CERN
- ❑ Faster construction, if better molds technique
- ❑ Lower high voltage, if higher readout gain
- ❑ Better spatial res, if reduced pitch or analog readout (COMPASS analog readout  $s_x = 60$  mm )
- ❑ Less material budget



**Thanks for**

**谢谢**

**your attention**